FEATURES AND SPECIFICATIONS

2.54mm (.100") Pitch QF 50™ Shrouded Header

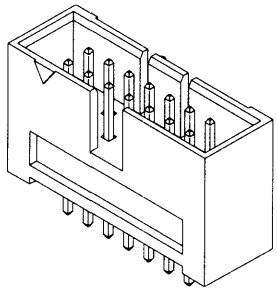
5332 Vertical, Dual Row Single Polarization

Features and Benefits
- Sizes 10 to 60 circuits
- Selective Gold- and Tin-plated versions

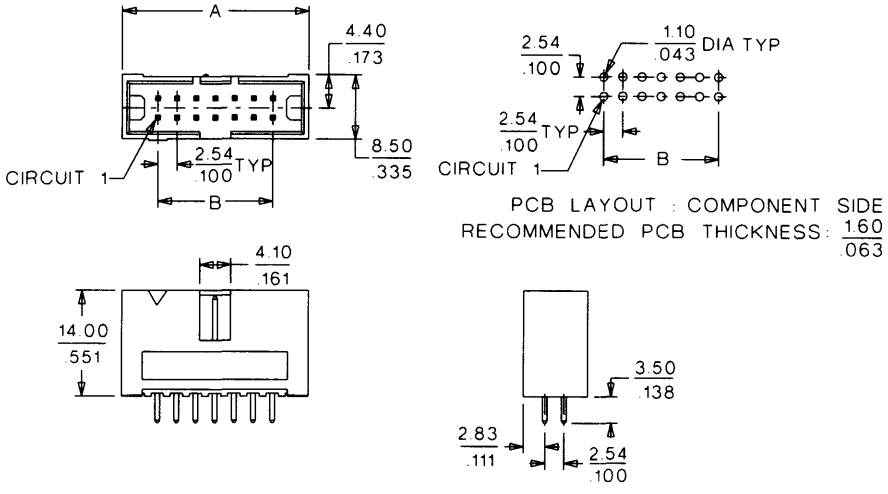
Reference Information
Packaging: Tray
UL File No.: E29179-E
Mates With: 5320-NA and 5320-NB
Designed In: Millimeters

Electrical
Current: 1.0A
Contact Resistance: 20mΩ max.
Dielectric Withstanding Voltage: 500V AC
Insulation Resistance: 1000 MΩ min.

Physical
Housing: Black glass-filled polyester, UL 94V-0
Contact: Brass
Contact Pin: 0.635mm (.025") square
Plating: See Table
Operating Temperature: -40 to +105°C



CATALOG DRAWING (FOR REFERENCE ONLY)



ORDERING INFORMATION AND DIMENSIONS

Circuits	Order No.		Dimension	
	Plating NGS1	Plating NT2	A	B
10	39-26-7105	39-28-5101	19.66 (.774)	10.16 (.400)
14	39-26-7145	39-28-5141	24.74 (.974)	15.24 (.600)
16	39-26-7165	39-28-5161	27.28 (1.074)	17.78 (.700)
20	39-26-7205	39-28-5201	32.36 (1.274)	22.86 (.900)
26	39-26-7265	39-28-5261	39.98 (1.574)	30.48 (1.200)
30	39-26-7305	39-28-5301	45.06 (1.774)	35.56 (1.400)
34	39-26-7345	39-28-5341	50.14 (1.974)	40.64 (1.600)
40	39-26-7405		57.76 (2.274)	48.26 (1.900)
50	39-26-7505		70.46 (2.774)	60.96 (2.400)
60	39-26-7605		83.16 (3.274)	73.66 (2.900)

Plating NGS1: 39µ" (1µm) min. Nickel underplate. Contact area: 4µ" (0.1µm) min. Gold.
Solder area: 3µm min. Tin/Lead.

Plating NT2: 35µ" (0.9µm) min. Tin overall